

# 40V 3A Schottky Diode – 1N5822

#### Schottky Barrier Rectifier diode in bare die form

Rev 1.0 18/01/19

#### Features:

- Guardring for over-voltage protection
- Very small conduction losses
- Extremely fast switching
- Low forward voltage drop
- High reliability tested grades.

### **Ordering Information**

The following part suffixes apply:

- No suffix MIL-STD-750 /2073 Visual Inspection
- "H" MIL-STD-750 /2073 Visual Inspection+ MIL-PRF-38534 Class H LAT
- "K" MIL-STD-750 /2073 Visual Inspection+ MIL-PRF-38534 Class K LAT

LAT = Lot Acceptance Test.

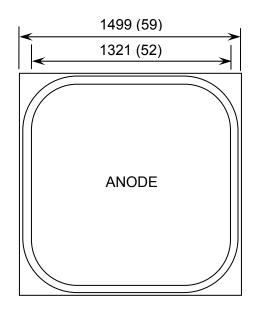
For further information on LAT process flows see below.

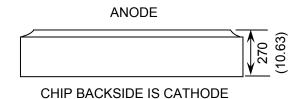
www.siliconsupplies.com\quality\bare-die-lot-qualification

## Supply Formats:

- Default Die in Waffle Pack (100 per tray capacity)
- Sawn Wafer on Tape By specific request
- Unsawn Wafer By specific request
- With additional electrical selection By specific request

### Die Dimensions in µm (mils)





### **Mechanical Specification**

Die Size (Unsawn)	1730 x 1730 59 x 59	μm mils	
Anode Pad Size	1321 x 1321 52 x 52	μm mils	
Die Thickness	270 (±20) 10.63 (0.79)	μm mils	
Top Metal Composition	Al ≥ 2.5μm		
Back Metal Composition	Ti/Ni/Ag ≥ 3μm		





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### Absolute Maximum Ratings T<sub>J</sub> = 25°C unless otherwise stated

PARAMETER	SYMBOL	VALUE	UNIT	
Repetitive peak reverse voltage	V <sub>RRM</sub>	40	V	
RMS Voltage	V <sub>RMS</sub>	28	V	
DC blocking voltage	V <sub>DC</sub>	40	V	
Average forward rectified current	I <sub>F(AV)</sub>	3	A	
Peak forward surge current, Test pulse – 8.3ms, half sine-wave	I <sub>FSM</sub>	80	A	
Thermal Impedance	Ze <sub>JX</sub>	2.5	°C/W	
Operating Junction temperature	TJ	-65 to 125	°C	
Storage Temperature Range	T <sub>STG</sub>	-65 to 150	°C	

### Electrical Characteristics T<sub>J</sub> = 25°C unless otherwise stated

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNIT
Maximum instantaneous V <sub>F</sub>		$V_{RWM} = 40V$ , $I_{FM} = 1A$	-	-	0.38	V
	V <sub>F</sub>	$V_{RWM} = 40V$ , $I_{FM} = 3A$	-	-	0.50	
		$V_{RWM} = 40V, I_{FM} = 9.4A$	-	-	0.70	
Maximum reverse leakage current I <sub>RM</sub> @ V <sub>RM</sub>	I @ V	$V_{RM} = 40V, T_J = 25^{\circ}C$	-	-	0.15	mA
	IRM W VRM	$V_{RM} = 40V, T_J = 100^{\circ}C$	-	-	12	
Junction Capacitance	Ст	$V_R = 5V$ , $T_C = 25^{\circ}C$ , $f_{SIG} = 1MHz$ , $V_{SIG} = 50mV$ (p-p)	-	-	265	pF

<sup>1.</sup> Pulse Width = 380µs, Duty Cycle = 2.0%

## Typical Characteristics T<sub>J</sub> = 25°C unless otherwise stated

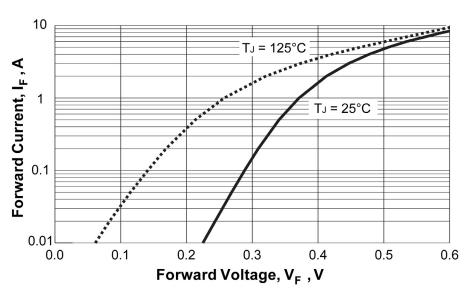


FIGURE 1. Forward Voltage Characteristics





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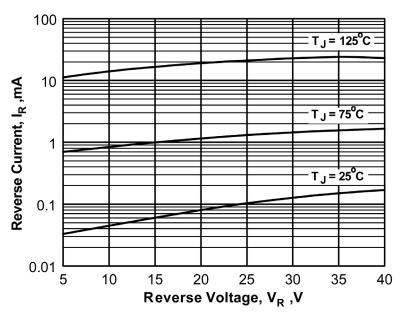


FIGURE 2. Reverse Current Versus Reverse Voltage

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